



Material Content Data Sheet



Halogen-Free

Sales Product Name IPD60R1K4C6

Issued

02. June 2021

MA# MA001715112

Package PG-TO252-3-341

Weight*

387.60 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.624	0.42	0.42	4190	4190
leadframe	inorganic material	phosphorus	7723-14-0	0.069	0.02		177	
	non noble metal	iron	7439-89-6	0.229	0.06		591	
	non noble metal	copper	7440-50-8	228.946	59.07	59.15	590682	591450
wire	non noble metal	aluminium	7429-90-5	0.414	0.11	0.11	1069	1069
encapsulation	organic material	carbon black	1333-86-4	0.393	0.10		1014	
	plastics	epoxy resin	-	11.919	3.08		30750	
	inorganic material	silicondioxide	60676-86-0	118.664	30.62	33.80	306153	337917
leadfinish	non noble metal	tin	7440-31-5	3.740	0.96	0.96	9649	9649
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1313	1313
solder	non noble metal	tin	7440-31-5	0.038	0.01		97	
	noble metal	silver	7440-22-4	0.047	0.01		122	
	non noble metal	lead	7439-92-1	1.802	0.46	0.48	4650	4869
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			15	
	non noble metal	iron	7439-89-6	0.019			50	
	non noble metal	copper	7440-50-8	19.177	4.95	4.95	49478	49543
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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